HLMP-331x, HLMP-341x, HLMP-351x Series

T-1³/₄ (5 mm) High Intensity LED Lamps



Data Sheet



Description

This family of $T-1^{3}/_{4}$ nondiffused LED lamps is specially designed for applications requiring higher on-axis intensity than is achievable with a standard lamp. The light generated is focused to a narrow beam to achieve this effect.

Selection Guide

	Lu	Luminous Intensity Iv (mcd) @ 10 mA			
Color	Part Number	Min.	Max.		
Red	HLMP-3316	24.8	-		
	HLMP-3316-I00xx	24.8	-		
Yellow	HLMP-3416	16.6	-		
Green	HLMP-3519	12.0	-		
	HLMP-3519-F00xx	12.0	-		

Features

- High intensity
- Choice of 3 bright colors
 - High Efficiency Red
 - Yellow
 - High Performance Green
- Popular T-1³/₄ diameter package
- Selected minimum intensities
- Narrow viewing angle
- General purpose leads
- Reliable and rugged
- Available on tape and reel

Part Numbering System



Package Dimensions



1. All dimensions are in millimeters (inches).

Notes:

2. An epoxy meniscus may extend about 1 mm (0.40") down the leads.

3. For PCB hole recommendations, see the Precautions section.

Electrical Characteristics at $T_A = 25^{\circ}C$

Symbol	Description	Device HLMP-	Min.	Тур.	Max.	Units	Test Conditions
lv	Luminous Intensity	3316	24.8	60.0		mcd	l _F = 10 mA (Figure 3)
		3416	16.6	50.0		mcd	I _F = 10 mA (Figure 8)
		3519	12.0	70.0		mcd	I _F = 10 mA (Figure 13)
20 ¹ / ₂	Including Angle Between Half Luminous Intensity Points	3316		35		Deg.	I _F = 10 mA See Note 1 (Figure 6)
		3416		35		Deg.	l _F = 10 mA See Note 1 (Figure 11)
		3519		24		Deg.	I _F = 10 mA See Note 1 (Figure 16)
λρεακ	Peak Wavelength	331X		635		nm	Measurement at Peak
		341X		583			(Figure 1)
		351X		565			
$\Delta\lambda_{1/2}$	Spectral Line Halfwidth	331X		40		nm	
		341X		36			
		351X		28			
$\overline{\lambda_d}$	Dominant Wavelength	331X		626		nm	See Note 2 (Figure 1)
		341X		585			
		351X		569			
τ _s	Speed of Response	331X		90		ns	
		341X		90			
		351X		500			
С	Capacitance	331X		11		pF	$V_{F} = 0; f = 1 MHz$
		341X		15			
		351X		18			
R _{θ_{J-PIN}}	Thermal Resistance	331X		260		°C/W	Junction to Cathode
		341X					Lead
		351X					
VF	Forward Voltage	331X		1.9	2.4	V	l _F = 10 mA (Figure 2)
		341X		2.0	2.4		l _F = 10 mA (Figure 7)
		351X		2.1	2.7		I _F = 10 mA (Figure 12)
V _R	Reverse Breakdown Volt.	All	5.0			V	$I_R = 100 \ \mu A$
ην	Luminous Efficacy	331X		145		lumens	See Note 3
•	-	341X		500		Watt	
		351X		595			

Notes:

1. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.

2. The dominant wavelength, λ_{d} , is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.

3. Radiant intensity, I_e , in watts/steradian, may be found from the equation $I_e = I_v/\eta_v$, where I_v is the luminous intensity in candelas and η_v is the luminous efficacy in lumens/watt.

Absolute Maximum Ratings at $T_A = 25^{\circ}C$

Parameter	331X Series	341X Series	351X Series	Units
Peak Forward Current	90	60	90	mA
Average Forward Current ^[1]	25	20	25	mA
DC Current ^[2]	30	20	30	mA
Power Dissipation ^[3]	135	85	135	mW
Reverse Voltage (I _R = 100 μA)	5	5	5	V
Transient Forward Current ^[4] (10 μsec Pulse)	500	500	500	mA
LED Junction Temperature	110	110	110	°C
Operating Temperature Range	-40 to +100	-40 to +100	-20 to +100	°C
Storage Temperature Range	-40 to +100	-40 to +100	-40 to +100	°C

Notes:

1. See Figure 5 (Red), 10 (Yellow), or 15 (Green) to establish pulsed operating conditions.

2. For Red and Green series derate linearly from 50°C at 0.5 mA/°C. For Yellow series derate linearly from 50°C at 0.2 mA/°C.

3. For Red and Green series derate power linearly from 25°C at 1.8 mW/°C. For Yellow series derate power linearly from 50°C at 1.6 mW/°C.

4. The transient peak current is the maximum non-recurring peak current that can be applied to the device without damaging the LED die and wirebond. It is not recommended that the device be operated at peak currents beyond the peak forward current listed in the Absolute Maximum Ratings.



Figure 1. Relative intensity vs. wavelength.

High Efficiency Red HLMP-331X Series



characteristics.



Figure 2. Forward current vs. forward voltage Figure 3. Relative luminous intensity vs. DC forward current.



Figure 4. Relative efficiency (luminous intensity per unit current) vs. peak LED current.



Figure 5. Maximum tolerable peak current vs. pulse duration (I_{DC} MAX as per MAX ratings).



Figure 6. Relative luminous intensity vs. angular displacement.

Yellow HLMP-341X Series



Figure 7. Forward current vs. forward voltage

characteristics.



Figure 8. Relative luminous intensity vs. DC forward current.



Figure 9. Relative efficiency (luminous intensity per unit current) vs. peak current.



Figure 10. Maximum tolerable peak current vs. pulse duration (I_{DC} MAX as per MAX ratings).



Figure 11. Relative luminous intensity vs. angular displacement.

Green HLMP-351X Series



Figure 12. Forward current vs. forward voltage characteristics.



Figure 13. Relative luminous intensity vs. DC forward current.



Figure 14. Relative efficiency (luminous intensity per unit current) vs. peak LED current.



Figure 15. Maximum tolerable peak current vs. pulse duration (I_{DC} MAX as per MAX ratings).



Figure 16. Relative luminous intensity vs. angular displacement. T-1³/₄ lamp.

Table 2. Intensity Bin Limit		Table 2. (Cont'd)			Table 2. (Cont'd)						
		Intensity R (mcd)	•	Intensity Range Intensity Range (mcd)	ange			Intensity Range (mcd)			
Color	Bin	Min.	Max.	Color	Bin	Min.	Max.	Color	Bin	Min.	Max.
	Н	15.5	24.8		G	16.6	26.5		E	7.6	12.0
	Ι	24.8	39.6		Н	26.5	42.3		F	12.0	19.1
	J	39.6	63.4		Ι	42.3	67.7		G	19.1	30.7
	К	63.4	101.5		J	67.7	108.2		Н	30.7	49.1
	L	101.5	162.4		К	108.2	173.2		Ι	49.1	78.5
	М	162.4	234.6		L	173.2	250.0		J	78.5	125.7
	Ν	234.6	340.0		М	250.0	360.0		К	125.7	201.1
	0	340.0	540.0	Yellow	Ν	360.0	510.0		L	201.1	289.0
Red	Р	540.0	850.0		0	510.0	800.0	Green	М	289.0	417.0
	Q	850.0	1200.0		Р	800.0	1250.0		Ν	417.0	680.0
	R	1200.0	1700.0		Q	1250.0	1800.0		0	680.0	1100.0
	S	1700.0	2400.0		R	1800.0	2900.0		Р	1100.0	1800.0
	Т	2400.0	3400.0		S	2900.0	4700.0		Q	1800.0	2700.0
	U	3400.0	4900.0		Т	4700.0	7200.0		R	2700.0	4300.0
	V	4900.0	7100.0		U	7200.0	11700.0		S	4300.0	6800.0
	W	7100.0	10200.0		V	11700.0	18000.0		Т	6800.0	10800
	Х	10200.0	14800.0		W	18000.0	27000.0		U	10800.0	16000
	Y	14800.0	21400.0						V	16000.0	25000
	Z	21400.0	30900.0						W	25000.0	40000

Maximum tolerance for each bin limit is $\pm 18\%$.

Color Categories

		Lambda	Lambda (nm)			
Color	Cat #	Min.	Max.			
	6	561.5	564.5			
	5	564.5	567.5			
Green	4	567.5	570.5			
	3	570.5	573.5			
	2	573.5	576.5			
	1	582.0	584.5			
	3	584.5	587.0			
Yellow	2	587.0	589.5			
	4	589.5	592.0			
	5	592.0	593.0			

Tolerance for each bin limit is \pm 0.5 nm.

Mechanical Option Matrix

Mechanical Option Code	Definition
00	Bulk Packaging, minimum increment 500 pcs/bag
01	Tape & Reel, crimped leads, minimum increment 1300 pcs/bag
02	Tape & Reel, straight leads, minimum increment 1300 pcs/bag
B1	Right Angle Housing, uneven leads, minimum increment 500 pcs/bag
B2	Right Angle Housing, even leads, minimum increment 500 pcs/bag

Note:

All Categories are established for classification of products. Products may not be available in all categories. Please contact your local Avago representative for further clarification/information.

Precautions

Lead Forming

- The leads of an LED lamp may be preformed or cut to length prior to insertion and soldering into PC board.
- If lead forming is required before soldering, care must be taken to avoid any excessive mechanical stress induced to LED package. Otherwise, cut the leads of LED to length after soldering process at room temperature. The solder joint formed will absorb the mechanical stress of the lead cutting from traveling to the LED chip die attach and wirebond.
- It is recommended that tooling made to precisely form and cut the leads to length rather than rely upon hand operation.

Soldering Conditions

- Care must be taken during PCB assembly and soldering process to prevent damage to LED component.
- The closest LED is allowed to solder on board is 1.59 mm below the body (encapsulant epoxy) for those parts without standoff.
- Recommended soldering conditions:

Wave Soldering	Manual Solder Dipping
105 °C Max.	_
30 sec Max.	_
250 °C Max.	260 °C Max.
3 sec Max.	5 sec Max.
	105 ℃ Max. 30 sec Max. 250 ℃ Max.



Figure 17. Recommended wave soldering profile.

- Wave soldering parameter must be set and maintained according to recommended temperature and dwell time in the solder wave. Customer is advised to periodically check on the soldering profile to ensure the soldering profile used is always conforming to recommended soldering condition.
- If necessary, use fixture to hold the LED component in proper orientation with respect to the PCB during soldering process.
- Proper handling is imperative to avoid excessive thermal stresses to LED components when heated. Therefore, the soldered PCB must be allowed to cool to room temperature, 25°C, before handling.
- Special attention must be given to board fabrication, solder masking, surface plating and lead holes size and component orientation to assure solderability.
- Recommended PC board plated through hole sizes for LED component leads:

	LED Component Lead Size	Diagonal	Plated Through -Hole Diameter
Lead size (typ.)	$0.45 \times 0.45 \text{ mm}$	0.636 mm	0.98 to 1.08 mm
	(0.018 × 0.018 in.)	(0.025 in)	(0.039 to 0.043 in)
Dambar shear-	0.65 mm	0.919 mm	_
off area (max.)	(0.026 in)	(0.036 in)	
Lead size (typ.)	0.50 × 0.50 mm	0.707 mm	1.05 to 1.15 mm
	(0.020 × 0.020 in.)	(0.028 in)	(0.041 to 0.045 in)
Dambar shear-	0.70 mm	0.99 mm	_
off area (max.)	(0.028 in)	(0.039 in)	

Note: Refer to application note AN1027 for more information on soldering LED components.

 BOTTOM SIDE OF PC BOARD	
 TOP SIDE OF PC BOARD	

CONVEYOR SPEED = 1.83 M/MIN (6 FT/MIN) PREHEAT SETTING = 150° C (100° C PCB) SOLDER WAVE TEMPERATURE = 245° C AIR KNIFE AIR TEMPERATURE = 390° C AIR KNIFE DISTANCE = 1.91 mm (0.25 IN.) AIR KNIFE ANGLE = 40SOLDER: SN63; FLUX: RMA

NOTE: ALLOW FOR BOARDS TO BE SUFFICIENTLY COOLED BEFORE EXERTING MECHANICAL FORCE.

For product information and a complete list of distributors, please go to our website: www.avagotech.com

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